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 TI **Copper**-thallium alloys with good heat resistance and electrical conductivity
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 PA Furukawa Electric Co., Ltd.
 SO Japan., 3 pp.
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	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 49007777	B4	19740222	JP 1970-87320	19701005
AB	The Cu alloy contains Tl 0.005-0.08 and O >0.0005%. The alloy is cooled from 900-1050.degree. at >5 .degree.C/min, hot worked at >750.degree., cold worked, and annealed at >600.degree..				

(3, 14, 19)